

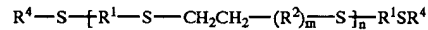
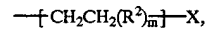


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(19) **United States**(12) **Patent Application Publication**  
**Zook et al.**(10) **Pub. No.: US 2003/0130480 A1**(43) **Pub. Date: Jul. 10, 2003**(54) **CHEMICALLY RESISTANT  
POLYTHIOETHERS AND FORMATION  
THEREOF**(60) Provisional application No. 60/188,106, filed on Mar.  
9, 2000.**Publication Classification**(75) Inventors: **Jonathan D. Zook**, Santa Clarita, CA  
(US); **David W. Jordan**, Northridge,  
CA (US); **Dean M. Willard**, New York,  
NY (US); **George Jones**, Tustin, CA  
(US); **Michael Cosman**, Irvine, CA  
(US)(51) **Int. Cl.<sup>7</sup> ..... C08G 75/00**(52) **U.S. Cl. .... 528/373**(57) **ABSTRACT**

A polythioether comprising:

Correspondence Address:

**GIFFORD, KRASS, GROH, SPRINKLE  
ANDERSON & CITKOWSKI, PC  
280 N OLD WOODARD AVE  
SUITE 400  
BIRMINGHAM, MI 48009 (US)**wherein  $R^1$  is a  $C_{1-10}$  alkyl,  $-(R^3Q)_pR^3-$  or  $C_6-C_{20}$  aryl  
where  $Q$  is O or S, each  $R^3$  is independently  $C_{1-6}$  alkyl, and  
 $p$  is an integer between 0 and 6;  $R^2$  is  $C_{1-6}$  alkyloxy or  $C_{5-12}$   
cycloalkyloxy,  $R^4$  is H,  $C_{1-6}$  alkyl,  $C_{1-6}$  alkyl alcohol and  
 $C_{6-8}$  alkyl substituted with(73) Assignee: **PBT Brands, Inc.**, Santa Clarita, CA  
(US)(21) Appl. No.: **10/368,135**(22) Filed: **Feb. 20, 2003****Related U.S. Application Data**(62) Division of application No. 09/802,427, filed on Mar.  
9, 2001, now Pat. No. 6,525,168.where  $X$  is a halogen,  $m$  is an integer between 1 and 4, and  
 $n$  is an integer selected to yield a molecular weight for said  
polythioether of between 1000 and 10,000 Daltons.

## CHEMICALLY RESISTANT POLYTHIOETHERS AND FORMATION THEREOF

### RELATED APPLICATIONS

[0001] This application is a divisional of U.S. patent application Ser. No. 09/802,427 filed Mar. 9, 2001, which claims priority of U.S. Provisional Patent Application Serial No. 60/188,106 filed Mar. 9, 2000.

### FIELD OF THE INVENTION

[0002] The present invention relates to polythioethers and, more particularly, to polythioethers having a specified ratio of constituent atoms therein and a process for the formation thereof.

### BACKGROUND OF THE INVENTION

[0003] Thiol-terminated sulfur-containing polymers have a long history of use in aerospace sealants because of their fuel resistant nature upon cross-linking. Among the commercially available polymeric compounds having sufficient sulfur content to exhibit this desirable property are the polysulfide polymers described, e.g., in U.S. Pat. No. 2,466,963 and sold under the trade name LP® polysulfide by Morton International of Chicago, Ill. and the alkyl side chain containing polythioether polymers described, e.g., in U.S. Pat. No. 4,366,307 that are sold in complete sealant formulations by PRC-DeSoto International, Inc. of Glendale, Calif. In addition to fuel resistance, polymers useful in this context must also have the desirable properties of low temperature flexibility, liquidity at room temperature, high temperature resistance, a reasonable cost of manufacture, and not be so malodorous as to prevent commercial acceptance of compositions that contain the subject polymers.

[0004] U.S. Pat. No. 4,366,307 teaches the use of hydroxyl-functional thioethers having pendent alkylene groups to obtain polymers having good flexibility and liquidity. However, the disclosed condensation reaction has a maximum yield of about 75% of the desired condensation product. Furthermore, the acid-catalyzed reaction of beta-hydroxysulfide monomers, such as thiodiglycol, yields significant quantities (typically not less than about 25%) of an aqueous solution of thermally stable and highly malodorous cyclic byproducts, such as 1-thia-4-oxa-cyclohexane. As a result, the commercial viability of the disclosed polymers is limited. Further, pendent alkylene chains increase the carbon content of the polymer necessitating a high sulfur content to achieve sufficient chemical resistance properties.

[0005] U.S. Pat. No. 5,959,071 teaches the use of pendant alkylene chains and high sulfur content to achieve the chemical resistance and room temperature liquidity required for aerospace sealant formulations.

[0006] Certain prior art work has developed hydroxyl-terminated polythioethers by condensing thiodiglycol in the presence of certain etherifying catalysts as, for example, shown in U.S. Pat. Nos. 3,312,743 and 3,335,189. Compounds produced by these patents give semi-crystalline waxy solids, gums or low molecular weight liquids that have limited commercial utility.

[0007] Another desirable feature in polymers suitable for use in aerospace sealants is high temperature resistance. Inclusion of covalently-bonded sulfur atoms in organic polymers has been shown to enhance high temperature performance. However, in the polysulfide polymers disclosed in U.S. Pat. No. 2,466,963, the multiple —S—S—

linkages in the polymer backbones result in compromised thermal resistance. In the polymers disclosed in U.S. Pat. No. 4,366,307, enhanced thermal stability is achieved through replacement of polysulfide linkages with polythioether (—S—) linkages. In practice, however, the disclosed materials have compromised thermal resistance due to traces of the residual acid condensation catalyst.

[0008] U.S. Pat. No. 5,912,319 teaches the use of combinations of certain polythiols with oxygenated dienes resulting in polythioether polymers that are liquids at room temperature and pressure and have desirable physical properties. Further, these combinations are substantially free of residual catalysts and malodorous cyclic byproducts. Unfortunately, the oxygenated dienes described are very difficult to prepare and only a limited number of commercial compounds are known to exist.

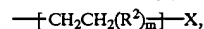
[0009] In addition to the foregoing deficiencies with the previously known polythioethers, the prior art polythioethers are typically also crystallizing products which, even if liquid or semi-liquid at ambient temperatures, when cooled sufficiently to solidify will not return to their previous liquid state even when the temperature is raised to ambient.

### SUMMARY OF THE INVENTION

[0010] A polythioether comprising:



[0011] wherein  $R^1$  is a  $C_{1-10}$  alkyl,  $-(R^3Q)_pR^3-$  or  $C-C_{20}$  aryl where Q is O or S, each  $R^3$  is independently  $C_{1-6}$  alkyl, and p is an integer between 0 and 6;  $R^2$  is  $C_{1-6}$  alkoxy or  $C_{5-12}$  cycloalkoxy,  $R^4$  is H,  $C_{1-6}$  alkyl,  $C_{1-6}$  alkyl alcohol and  $C_{0-6}$  alkyl substituted with

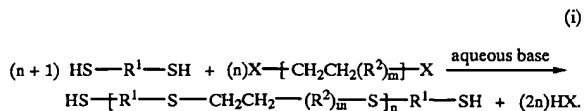


[0012] where X is a halogen, m is an integer between 1 and 4, and n is an integer selected to yield a molecular weight for said polythioether of between 1000 and 10,000 Daltons. A polyfunctionalizing agent is optionally provided in order to increase the functionality of a polythioether from 2 to 4 with the most preferred range being 2.05 to 3.00.

[0013] A process for forming such a polythioether includes the step of reacting a polythiol with a polyhalide in the presence of an aqueous base. The use of a polythioether is contemplated as an aerospace sealant.

### DETAILED DESCRIPTION OF THE INVENTION

[0014] This invention consists of a polythioether polymer made by the reaction of a thiol (dithiol) with a polyhalide in an aqueous base. The reaction may be illustrated as follows:



[0015] In the above illustration, "n" is a number such that a molecular weight of about 1000-10,000 Daltons is obtained resulting in material having a viscosity of less than 1000 poise.  $R^1$  is a  $C_{1-10}$  alkyl,  $-(R^3Q)_pR^3-$  or  $C_6-C_{20}$  aryl

where Q is O or S, each  $R^3$  is independently  $C_{1-6}$  alkyl, and p is an integer between 0 and 6. Substituents on  $R^1$  are those which do not interfere with the curing reaction of the polythiol with either a polyepoxide or polydiene. Thus,  $R^2$  is free of reactive unsaturated carbon to carbon bonds, as well as highly water sensitive species. Preferably,  $R^1$  is a linear alkyl. Preferred heteroatoms are S and O.  $R^2$  is a  $C_1$ - $C_6$  alkyloxy or  $C_5$ - $C_{12}$  cycloalkyloxy, most preferably  $-\text{OCH}_2\text{CH}_2-$  or  $-\text{OCH}_2\text{OCH}_2\text{CH}_2-$ . X is a halogen, F, Cl, Br or I and most preferably Cl.

[0016] Suitable thiols illustratively include ethanedithiol, vinylcyclohexyldithiol, dicyclopentadienedithiol, dipentene dimercaptan, and hexanedithiol. Preferred thiols contain heteroatoms. Examples of which illustratively include dimercaptodiethyl sulfide (DMS) with  $R^1$  of  $\text{CH}_2\text{CH}_2\text{SCH}_2\text{CH}_2$ , dimercaptodiethyl ether (DMDE) with  $R^1$  of  $\text{CH}_2\text{CH}_2\text{OCH}_2\text{CH}_2$  and dimercaptodioxaoctane (DMDO) with  $R^1$  of  $\text{CH}_2\text{CH}_2\text{OCH}_2\text{CH}_2\text{OCH}_2\text{CH}_2$ .

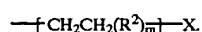
[0017] A polyhalide is chosen in conjugation with a polythiol to impart chemical resistance to the resulting polythioether, especially in the presence of jet reference fuel 1 (JRF). Chemical resistance is manifest at a molecular level by maintaining the atomic percent ratio C:S:O in the range 35-49:20-60:0-20. Thus, it will be apparent to those skilled in the art that pendant aliphatic moieties on the reactant polythiols and polyhalides necessitates an increase in chain S content to maintain the inventive polythioether atomic ratio and as such are generally disfavored.

[0018] Suitable polyhalides illustratively include di- and tri-halides such as 1,2-dichloroethane and 1,2,3-trichloropropane. The blend of halide monomer in one mode of modifying polymer functionality. Oxygenated polyhalides are most preferred in order to maintain the carbon atomic percent of the resulting polythioether below 50 percent. Examples of preferably polyhalides include  $\text{Cl}-\text{CH}_2\text{CH}_2\text{OCH}_2\text{CH}_2\text{OCH}_2\text{CH}_2-\text{Cl}$  and  $\text{Cl}-\text{CH}_2\text{CH}_2\text{OCH}_2\text{OCH}_2\text{CH}_2-\text{Cl}$ .

[0019] The aqueous base used to prepare polymers of this invention includes solutions of both inorganic and organic bases. Suitable inorganic bases include, but are not limited to, sodium and potassium hydroxide. Organic bases include any of a number of water soluble or dispersible tertiary amines such as pyridine.

[0020] In the representative reaction scheme illustrated above, the subscript n is chosen such that the resulting polymer has a molecular weight, Tg, and room temperature viscosity within the requisite range, for example, of an aerospace sealant. Preferred molecular weight includes 1000-6000 Daltons. In one embodiment, Tg should be as low as possible but below  $-40^\circ\text{C}$ . Finally, room temperature viscosity should be below 1000 poise.

[0021] While in the first preferred embodiment of the present invention as summarized by Formula I, an excess of dithiol is present to assure thiol termination of the resulting polythioether polymer, it is appreciated that by varying the relative amounts of polythiol relative to polyhalide, that polymers can be prepared that have not only terminal thiol groups, but a generic terminus  $R^4$  terminal where  $R^4$  is H,  $C_{1-6}$  alkyl,  $C_{1-6}$  alkyl alcohol, and  $C_{0-6}$  alkyl substituted with



[0022] Furthermore, the polythioether polymers thus formed need not be further reacted prior to cure or, alterna-

tively, are further reacted with other compounds to form capped polythioether polymers. Capping of polythioethers of the present invention affords the opportunity to include additional terminal functionalities into the inventive polymers. Such capping moieties illustratively include hydroxyl, olefin, epoxy, cyano, isocyanate, silyl, siloxy, secondary amine and alkyl groups.

[0023] In another embodiment, the inventive polythioether is greater than difunctional and is represented by the formula:  $\text{B}-(\text{I}-\text{R}^4)_z$  where B is a z-valent residue of a polyfunctionalizing agent, z is an integer value from 3 to 6, I is the resulting polythioether of Formula I less the terminal hydrogen groups, and  $R^4$  is H,  $C_{1-6}$  alkyl,  $C_{1-6}$  alkyl alcohol, and  $C_{0-6}$  alkyl substituted with



[0024] Preferably, the average functionality, as defined as the number of reactive groups per polythioether molecule, is above 2 and, more preferably, ranges between about 2.05 and about 3.00.

[0025] In aerospace sealant applications, the polythioether polymer derived according to the invention may be combined with suitable lightweight fillers. Typically, a polythioether polymer is present at from about 40 to about 80 weight percent, 0.3 to 1.5 weight percent lightweight fillers or 10 to 50 weight percent of conventional inorganic fillers, 0.1 to 2 weight percent curing agent, and the remainder of the composition optionally including one or more additives of: pigments, cure accelerators, surfactants, adhesion promoters, thixotropic agents and solvents. Suitable lightweight fillers for use in this invention may be organic, inorganic, or a composite of both. They fall within two categories—microspheres and amorphous fillers. The amounts of the microspheres and amorphous lightweight fillers used in the composition of the invention may be from about 0.3 to about 10 percent and from about 4 to 15 percent of the total weight of the composition, respectively. The specific gravity (s.g.) of the microspheres ranges from about 0.1 to 0.7 and are exemplified by polystyrene foam, microspheres of polyacrylates and polyolefins, and silica microspheres having particle sizes ranging from 5 to 100 microns and a specific gravity of 0.25 (ECCOSPHERES®, W. R. Grace & Co.). Other examples include alumina/silica microspheres having particle sizes in the range of 5 to 300 microns and a specific gravity of 0.7 (FILLITE®, Pluess-Stauffer International), aluminum silicate microspheres having a specific gravity of from about 0.45 to about 0.7 (Z-LIGHT®), and calcium carbonate-coated polyvinylidene copolymer microspheres having a specific gravity of 0.13 (DUALITE 6001AE®, Pierce & Stevens Corp.).

[0026] Suitable amorphous lightweight fillers for use in this invention have a specific gravity ranging from about 1.0 to about 2.2 and are exemplified by calcium silicates, fumed silica, precipitated silica, and polyethylene. Examples include calcium silicate having a specific gravity of from 2.1 to 2.2 and a particle size of from 3 to 4 microns (HUBER-SORB HS-600®, J. M. Huber Corp.) and fumed silica having a specific gravity of 1.7 to 1.8 with a particle size less than 1 (CAB-O-SIL TS-720®, Cabot Corp.). Other examples include precipitated silica having a specific gravity of from 2 to 2.1 (HI-SIL TS-7000®, PPG Industries), and polyethylene having a specific gravity of from 1 to 1.1 and a particle size of from 10 to 20 microns (SHAMROCK S-395®, Shamrock Technologies Inc.).

[0027] Table I illustrates the results of reacting various thiols and polyhalides in aqueous base:

TABLE I

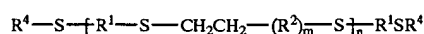
Thiol	Halide	% Yield*	Carbon %	Hydrogen %	Sulfur %	Oxygen %	Physical State	JRF Resistance
DMDS	Cl—CH <sub>2</sub> CH <sub>2</sub> —Cl	97	40	7	53	0	Semi-solid	Excellent
DMDS	Cl—CH <sub>2</sub> CH <sub>2</sub> OCH <sub>2</sub> CH <sub>2</sub> —Cl	99	43	7	43	7	Liquid	Excellent
DMDS	Cl—CH <sub>2</sub> CH <sub>2</sub> OCH <sub>2</sub> CH <sub>2</sub> OCH <sub>2</sub> CH <sub>2</sub> —Cl	98	45	7	36	12	Liquid	Good
DMDO	Cl—CH <sub>2</sub> CH <sub>2</sub> —Cl	99	46	8	31	15	Liquid	Good
DMDO	Cl—CH <sub>2</sub> CH <sub>2</sub> OCH <sub>2</sub> CH <sub>2</sub> —Cl	99	48	8	25	19	Liquid	Acceptable
DMDO	Cl—CH <sub>2</sub> CH <sub>2</sub> OCH <sub>2</sub> CH <sub>2</sub> OCH <sub>2</sub> CH <sub>2</sub> —Cl	98	49	8	21	22	Liquid	Marginal

\*Expressed as percent of theoretical

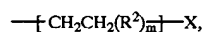
[0028] As Table I shows, according to the reaction process of the invention, liquid polythioethers are produced without cyclized byproducts. In this manner, the tendency for production of highly malodorous cyclic byproducts is greatly reduced. Further, monomer blend ratios useful in the context of this invention are chosen such that the following composition is preserved: carbon content, less than 49 percent by weight; sulfur content, 21-45 percent by weight; and oxygen content, less than 20 percent by weight. In this manner, the chemical resistance properties of the resulting polymer are suitable for applications including, but not limited to, aerospace sealants.

[0029] All patents and publications cited herein are hereby incorporated by reference to the same extent as if each individual patent or publication was explicitly and individually incorporated by reference.

1. A process for form-ing a polythioether comprising:



wherein R<sup>1</sup> is a C<sub>1-10</sub> alkyl, —(R<sup>3</sup>Q)<sub>p</sub>R<sup>3</sup>— or C<sub>6</sub>-C<sub>20</sub> aryl where Q is O or S, each R<sup>3</sup> is independently C<sub>1-6</sub> alkyl, and p is an integer between 0 and 6; R<sup>2</sup> is C<sub>1-6</sub> alkyloxy or C<sub>5-12</sub> cycloalkyloxy, R<sup>4</sup> is H, C<sub>1-6</sub> alkyl, C<sub>1-6</sub> alkyl alcohol and C<sub>0-6</sub> alkyl substituted with



where X is a halogen, m is an integer between 1 and 4, and n is an integer selected to yield a molecular weight for said polythioether of between 1000 and 10,000 Daltons comprising the step of: reacting a polythiol and a polyhalide in the presence of an aqueous base.

2. The process of claim 1 wherein said polythiol is a dithiol.

3. The process of claim 2 wherein the dithiol is selected from the group consisting of: ethanedithiol, vinylcyclohexyldithiol, dicyclopentadienedithiol, dipentene dimercaptan, hexanedithiol, dimercaptodiethyl sulfide, dimercaptodiethyl ether, and dimercaptodioxaoctane.

4. The process of claim 1 wherein said polyhalide is a dihalide.

5. The process of claim 4 wherein said dihalide is selected from the group consisting of: dichloroalkane and a polyglycol dihalide.

6. The process of claim 1 wherein said polyhalide is a polychloride.

7. The process of claim 1 wherein said polyhalide is a trihalide.

8. The process of claim 1 wherein n+1 equivalents of thiol of said polythiol are reacted with n equivalents of halide of said polyhalide.

9. A curable composition comprising:

42 to 80 weight percent of a polythioether polymer according to claim 1,

0.3 to 15 weight percent of a lightweight filler and 0.1 to 20 weight percent of a curing agent.

10. The curable composition of claim 9 further comprising one or more additives selected from the group consisting of: pigments, cure accelerators, surfactants, adhesion promoters, thixotropic agents and solvents.

11. The curable composition of claim 10 wherein said lightweight filler comprises microspheres.

12. The curable composition of claim 10 wherein said lightweight filler comprises an amorphous material.

\* \* \* \* \*